# MJL3281A (NPN) MJL1302A (PNP)

# **Complementary Bipolar Power Transistors**

### **Features**

- Exceptional Safe Operating Area
- NPN/PNP Gain Matching within 10% from 50 mA to 5 A
- Excellent Gain Linearity
- High BVCEO
- High Frequency
- These Devices are Pb-Free and are RoHS Compliant\*

### **Benefits**

- Reliable Performance at Higher Powers
- Symmetrical Characteristics in Complementary Configurations
- Accurate Reproduction of Input Signal
- Greater Dynamic Range
- High Amplifier Bandwidth

### **Applications**

- High-End Consumer Audio Products
  - Home Amplifiers
  - ♦ Home Receivers
- Professional Audio Amplifiers
  - Theater and Stadium Sound Systems
  - Public Address Systems (PAs)

### MAXIMUM RATINGS (T<sub>.J</sub> = 25°C unless otherwise noted)

| Rating   | Symbol                            | Value           | Unit          |
|--|-----------------------------------|-----------------|---------------|
| Collector-Emitter Voltage  | V <sub>CEO</sub>                  | 260             | Vdc           |
| Collector-Base Voltage   | V <sub>CBO</sub>                  | 260             | Vdc           |
| Emitter-Base Voltage   | V <sub>EBO</sub>                  | 5.0             | Vdc           |
| Collector-Emitter Voltage - 1.5 V                                    | V <sub>CEX</sub>                  | 260             | Vdc           |
| Collector Current - Continuous                                       | Ic                                | 15              | Adc           |
| Collector Current - Peak (Note 1)                                    | I <sub>CM</sub>                   | 25              | Adc           |
| Base Current - Continuous  | I <sub>B</sub>                    | 1.5             | Adc           |
| Total Power Dissipation @ T <sub>C</sub> = 25°C<br>Derate Above 25°C | P <sub>D</sub>                    | 200<br>1.43     | Watts<br>W/°C |
| Operating and Storage Junction<br>Temperature Range                  | T <sub>J</sub> , T <sub>stg</sub> | – 65 to<br>+150 | °C            |

### THERMAL CHARACTERISTICS

| Characteristic                       | Symbol          | Max   | Unit |
|--------------------------------------|-----------------|-------|------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 0.625 | °C/W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1

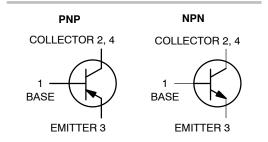
1. Pulse Test: Pulse Width = 5 ms, Duty Cycle < 10%.



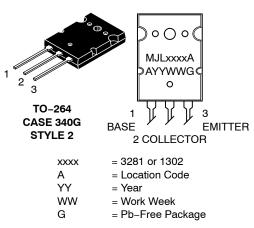
### ON Semiconductor®

http://onsemi.com

15 AMPERES
COMPLEMENTARY
SILICON POWER
TRANSISTORS
260 VOLTS
200 WATTS



### **MARKING DIAGRAM**



### **ORDERING INFORMATION**

| Device    | Package             | Shipping      |
|-----------|---------------------|---------------|
| MJL3281AG | TO-264<br>(Pb-Free) | 25 Units/Rail |
| MJL1302AG | TO-264<br>(Pb-Free) | 25 Units/Rail |

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

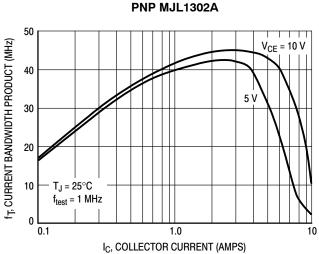
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# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

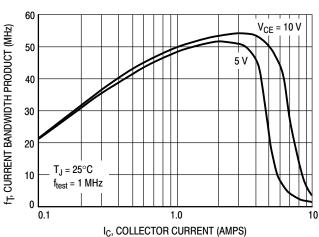
| Characteristic   | Symbol                | Min                        | Max                      | Unit |
|--|-----------------------|----------------------------|--------------------------|------|
| OFF CHARACTERISTICS  |                       |                            |                          | •    |
| Collector–Emitter Sustaining Voltage (I <sub>C</sub> = 100 mAdc, I <sub>B</sub> = 0)   | V <sub>CEO(sus)</sub> | 260                        | -                        | Vdc  |
| Collector Cutoff Current (V <sub>CB</sub> = 260 Vdc, I <sub>E</sub> = 0)   | Ісво                  | -                          | 50                       | μAdc |
| Emitter Cutoff Current (V <sub>EB</sub> = 5 Vdc, I <sub>C</sub> = 0)   | I <sub>EBO</sub>      | -                          | 5                        | μAdc |
| SECOND BREAKDOWN   |                       |                            |                          |      |
| Second Breakdown Collector with Base Forward Biased (V <sub>CE</sub> = 50 Vdc, t = 1 s (non-repetitive) (V <sub>CE</sub> = 100 Vdc, t = 1 s (non-repetitive) | I <sub>S/b</sub>      | 4<br>1                     |                          | Adc  |
| ON CHARACTERISTICS   | ,                     |                            |                          |      |
| DC Current Gain  | h <sub>FE</sub>       | 75<br>75<br>75<br>75<br>75 | 150<br>150<br>150<br>150 |      |
| Collector-Emitter Saturation Voltage (I <sub>C</sub> = 10 Adc, I <sub>B</sub> = 1 Adc)   | V <sub>CE(sat)</sub>  | -                          | 3                        | Vdc  |
| DYNAMIC CHARACTERISTICS  |                       |                            |                          |      |
| Current-Gain - Bandwidth Product<br>(I <sub>C</sub> = 1 Adc, V <sub>CE</sub> = 5 Vdc, f <sub>test</sub> = 1 MHz)   | f⊤                    | 30                         | -                        | MHz  |
| Output Capacitance<br>(V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f <sub>test</sub> = 1 MHz)  | C <sub>ob</sub>       | -                          | 600                      | pF   |

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### **TYPICAL CHARACTERISTICS**



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NPN MJL3281A

Figure 1. Typical Current Gain Bandwidth Product

Figure 2. Typical Current Gain Bandwidth Product

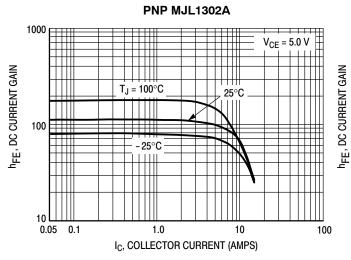


Figure 3. DC Current Gain

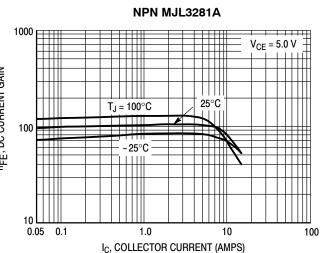


Figure 4. DC Current Gain

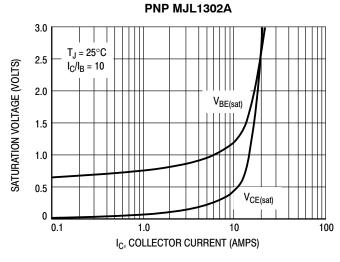


Figure 5. Typical Saturation Voltages

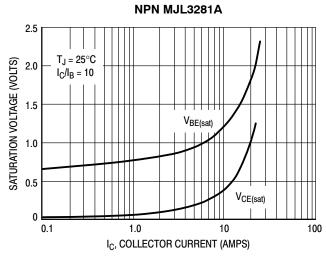


Figure 6. Typical Saturation Voltages

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### **TYPICAL CHARACTERISTICS**

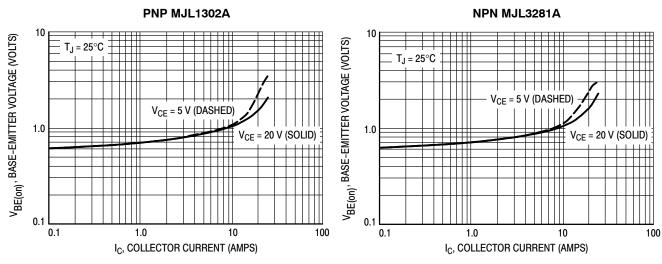


Figure 7. Typical Base-Emitter Voltage

Figure 8. Typical Base-Emitter Voltage

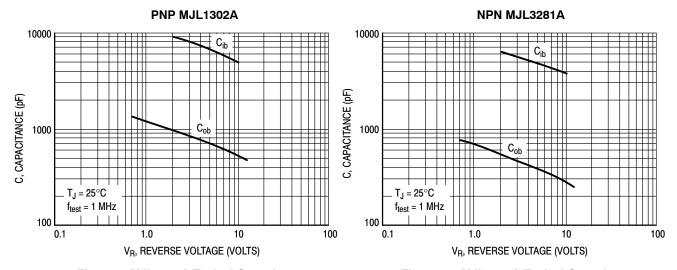


Figure 9. MJL1302A Typical Capacitance

Figure 10. MJL3281A Typical Capacitance

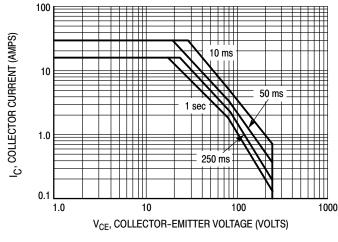
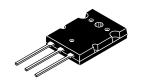


Figure 11. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

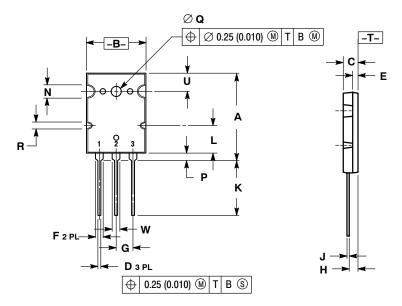
The data of Figure 11 is based on  $T_{J(pk)}$  = 150°C;  $T_C$  is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.



TO-3BPL (TO-264) CASE 340G-02 **ISSUE J** 

**DATE 17 DEC 2004** 

### SCALE 1:2



#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.

|     | MILLIMETERS |      | INC       | HES   |
|-----|-------------|------|-----------|-------|
| DIM | MIN         | MAX  | MIN       | MAX   |
| Α   | 28.0        | 29.0 | 1.102     | 1.142 |
| В   | 19.3        | 20.3 | 0.760     | 0.800 |
| С   | 4.7         | 5.3  | 0.185     | 0.209 |
| D   | 0.93        | 1.48 | 0.037     | 0.058 |
| E   | 1.9         | 2.1  | 0.075     | 0.083 |
| F   | 2.2         | 2.4  | 0.087     | 0.102 |
| G   | 5.45 BSC    |      | 0.215 BSC |       |
| Н   | 2.6         | 3.0  | 0.102     | 0.118 |
| J   | 0.43        | 0.78 | 0.017     | 0.031 |
| K   | 17.6        | 18.8 | 0.693     | 0.740 |
| L   | 11.2 REF    |      | 0.411 REF |       |
| N   | 4.35 REF    |      | 0.172 REF |       |
| Р   | 2.2         | 2.6  | 0.087     | 0.102 |
| Q   | 3.1         | 3.5  | 0.122     | 0.137 |
| R   | 2.25 REF    |      | 0.089     | REF   |
| U   | 6.3 REF     |      | 0.248 REF |       |
| W   | 2.8         | 3.2  | 0.110     | 0.125 |

### **GENERIC MARKING DIAGRAM\***

| STYLE 1: |        |  |  |
|----------|--------|--|--|
| PIN 1.   | GATE   |  |  |
| 2.       | DRAIN  |  |  |
| 3.       | SOURCE |  |  |

STYLE 2: PIN 1. BASE 2. COLLECTOR

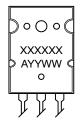
EMITTER

STYLE 3: PIN 1. GATE 2. SOURCE

DRAIN

STYLE 4: PIN 1. DRAIN 2. SOURCE GATE 3.

STYLE 5: PIN 1. GATE 2. COLLECTOR EMITTER



XXXXXX = Specific Device Code

Α = Location Code

YY = Year WW = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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|------------------|------------------|---|-------------|
| DESCRIPTION:     | TO-3BPL (TO-264) |   | PAGE 1 OF 1 |

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